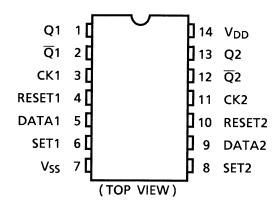
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC4013BP,TC4013BF

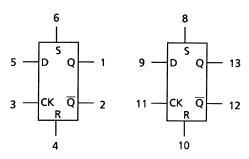
TC4013B Dual D-Type Flip Flop

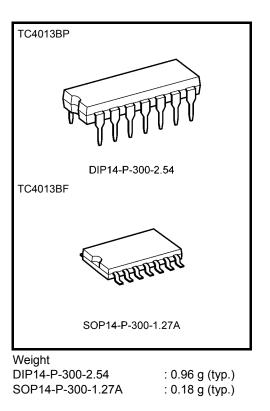
TC4013B contains two independent circuits of D type flip-flop. The input level applied to DATA input are transferred to Q and  $\overline{Q}$  output by rising edge of the clock pulse. When SET input is placed at "H", and RESET input is placed at "L", outputs become Q = "H", and  $\overline{Q} =$  "L". When RESET input is placed at "H", and SET input is placed at "L", outputs become Q = "L", and  $\overline{Q} =$  "H". When become Q = "L", and  $\overline{Q} =$  "H", outputs become Q = "L", and  $\overline{Q} =$  "H". When both of RESET input and SET input are at "H", outputs become Q = "H".

## **Pin Assignment**



#### **Block Diagram**





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# Truth Table

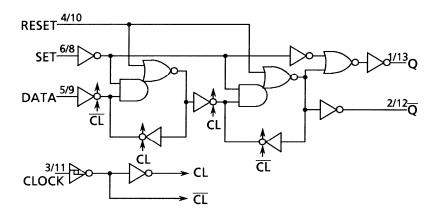
	Inp	Outputs			
RESET	SET	DATA CKA		Qn + 1	$\overline{Q}n + 1$
L	Н	*	*	Н	L
н	L	*	*	L	Н
н	Н	*	*	Н	Н
L	L	L		L	Н
L	L	Н		Н	L
L	L	*		Qn <sup>.</sup>	Qn

\*: Don't care

 $\Delta$ : Level change

·: No change

# Logic Diagram



# Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
DC supply voltage	V <sub>DD</sub>	$V_{SS}-0.5V_{SS}+20$	V
Input voltage	V <sub>IN</sub>	$V_{SS} - 0.5 \text{-} V_{DD} + 0.5$	V
Output voltage	V <sub>OUT</sub>	$V_{SS} - 0.5 \text{-} V_{DD} + 0.5$	V
DC input current	I <sub>IN</sub>	±10	mA
Power dissipation	PD	300 (DIP)/180 (SOIC)	mW
Operating temperature range	T <sub>opr</sub>	-40~85	°C
Storage temperature range	T <sub>stg</sub>	-65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (V<sub>SS</sub> = 0 V) (Note)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
DC supply voltage	V <sub>DD</sub>	—	3	_	18	V
Input voltage	V <sub>IN</sub>		0		V <sub>DD</sub>	V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{DD}$  or  $V_{SS}$ .

# Static Electrical Characteristics ( $V_{SS} = 0 V$ )

Characteristics Symbol		Sym-	Test Condition		-40°C		25°C			85°C		11:0:1	
			V <sub>DD</sub> (V)	Min	Max	Min	Тур.	Max	Min	Max	Unit		
High-level output V <sub>OH</sub>			I <sub>OUT</sub>   < 1 μΑ	5	4.95	_	4.95	5.00		4.95	_		
		VOH		10	9.95	—	9.95	10.00	_	9.95	—	V	
			$V_{IN} = V_{SS},  V_{DD}$	15	14.95	_	14.95	15.00	_	14.95	_		
			I <sub>OUT</sub>   < 1 μΑ	5		0.05	—	0.00	0.05	_	0.05		
Low-level voltage	output	V <sub>OL</sub>	$V_{IN} = V_{SS}, V_{DD}$	10	—	0.05	—	0.00	0.05	—	0.05	V	
Ŭ			VIN – VSS, VDD	15		0.05	—	0.00	0.05	—	0.05		
			V <sub>OH</sub> = 4.6 V	5	-0.61		-0.51	-1.0		-0.42			
			$V_{OH} = 2.5 V$	5	-2.50	—	-2.10	-4.0	—	-1.70	—		
Output hig	h current	IOH	V <sub>OH</sub> = 9.5 V	10	-1.50	—	-1.30	-2.2	_	-1.10	—	mA	
			V <sub>OH</sub> = 13.5 V	15	-4.00	—	-3.40	-9.0	_	-2.80	—		
			$V_{IN}=V_{SS},V_{DD}$										
			V <sub>OL</sub> = 0.4 V	5	0.61		0.51	1.2		0.42			
Output Iou	( current	1	$V_{OL} = 0.5 V$	10	1.50	—	1.30	3.2	—	1.10	—	mA	
Output low current	IOL	V <sub>OL</sub> = 1.5 V	15	4.00	—	3.40	12.0	—	2.80	—	IIIA		
			$V_{IN} = V_{SS}, V_{DD}$										
		VIH	V <sub>OUT</sub> = 0.5 V, 4.5 V	5	3.5	_	3.5	2.75	_	3.50	_	V	
Incut bigh	voltaga		V <sub>OUT</sub> = 1.0 V, 9.0 V	10	7.0	—	7.0	5.50	_	7.00	—		
Input high	voltage		V <sub>OUT</sub> = 1.5 V, 13.5 V	15	11.0	—	11.0	8.25	_	11.00	—		
			$ I_{OUT}  < 1  \mu A$										
			V <sub>OUT</sub> = 0.5 V, 4.5 V	5	_	1.5	_	2.25	1.5	_	1.5		
Input low voltage		VIL	V <sub>OUT</sub> = 1.0 V, 9.0 V	10	_	3.0	_	4.50	3.0	_	3.0	v	
			V <sub>OUT</sub> = 1.5 V, 13.5 V	15	—	4.0	—	6.75	4.0	—	4.0		
			$ I_{OUT}  < 1  \mu A$										
Input	"H" level	IIН	V <sub>IH</sub> = 18 V	18	_	0.1	_	10 <sup>-5</sup>	0.1	_	1.0		
current	"L" level	١ <sub>١L</sub>	$V_{IL} = 0 V$	18	_	-0.1		-10 <sup>-5</sup>	-0.1		-1.0	μA	
				5		1		0.002	1		30		
Quiescent current	Quiescent supply		$V_{IN} = V_{SS}, V_{DD}$	10	—	2	_	0.004	2	_	60	μA	
			(Note)	15	_	4		0.008	4	—	120		

Note: All valid input combinations.

# Dynamic Electrical Characteristics (Ta = $25^{\circ}$ C, V<sub>SS</sub> = 0 V, C<sub>L</sub> = 50 pF)

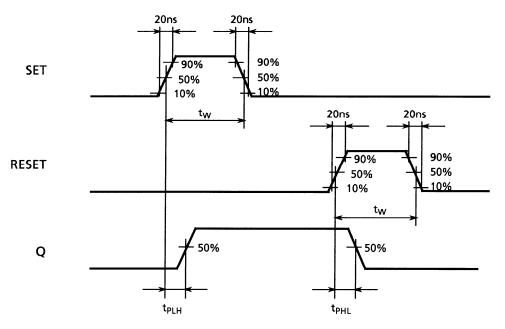
Characteristics	Currente e l	Test Condition		Min	Ture	Max	Unit
Characteristics	Symbol		V <sub>DD</sub> (V)	Min	Тур.	p. wax	Unit
Output transition time			5	_	70	200	
(low to high)	t <sub>TLH</sub>	—	10		35	100	ns
(low to high)			15		30	80	
Output transition time			5		70	200	
Output transition time (high to low)	t <sub>THL</sub>	—	10	—	35	100	ns
(high to low)			15	—	30	80	
Dranagation dalay time	<b>.</b>		5		130	300	ns
Propagation delay time (CK-Q, $\overline{Q}$ )	<sup>t</sup> pLH	_	10		65	130	
(CK-Q, Q)	<sup>t</sup> pHL		15	—	50	90	
Drene seties deles time			5	_	110	300	
Propagation delay time (SET, RESET-Q, $\overline{Q}$ )	t <sub>pLH</sub>	_	10		50	130	ns
(SEI, RESEI-Q, Q)			15	—	40	90	
Descention delay firm			5	_	110	300	
Propagation delay time	t <sub>pHL</sub>	—	10		50	130	ns
(SET, RESET-Q, $\overline{Q}$ )			15	_	40	90	
	fCL	_	5	3.5	8		
Max clock frequency			10	8.0	16	_	MHz
			15	12.0	20	_	
		_	5	No limit			μs
Max clock input rise time	trCL		10				
Max clock input fall time	t <sub>fCL</sub>		15				
NAtion in the second state		_	5	_	60	180	ns
Min pulse width	tw		10	_	30	80	
(SET, RESET)			15		25	50	
			5		60	140	ns
Min clock pulse width	t <sub>W</sub>	—	10	_	30	60	
			15	—	25	40	
Min act un time			5			40	
Min set-up time	t <sub>su</sub>	_	10	—		20	ns
(DATA-CK)			15	—	—	15	
Min hold time			5		20	40	
	t <sub>H</sub>	—	10	—	10	20	ns
(DATA-CK)			15	—	6	15	
Min romoval time			5			40	
Min removal time	t <sub>rem</sub>	—	10	—		20	ns
(SET, RESET-CK)			15	—	—	15	
Input capacitance	C <sub>IN</sub>				5	7.5	pF

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# Waveform for Measurement of Dynamic Characteristics

#### Waveform 1 20ns 20ns 90% **9**0% DATA 50% 50% 50% 10% 10% t<sub>H</sub> tsu t<sub>H</sub> 20ns 20ns 90% 90% CLOCK 50% 50% 10% 10% $\mathbf{t}_{\mathsf{TLH}}$ t<sub>тнĻ</sub> **9**0% 90% Q 50% 50% 10% 10% t<sub>PLH</sub> t<sub>PHL</sub>

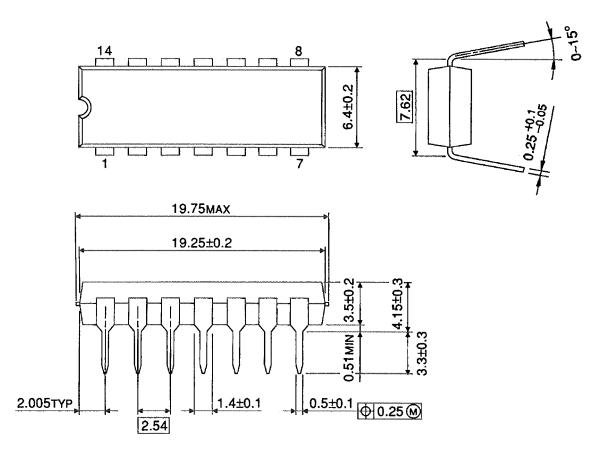
#### Waveform 2



### **Package Dimensions**

DIP14-P-300-2.54

Unit : mm



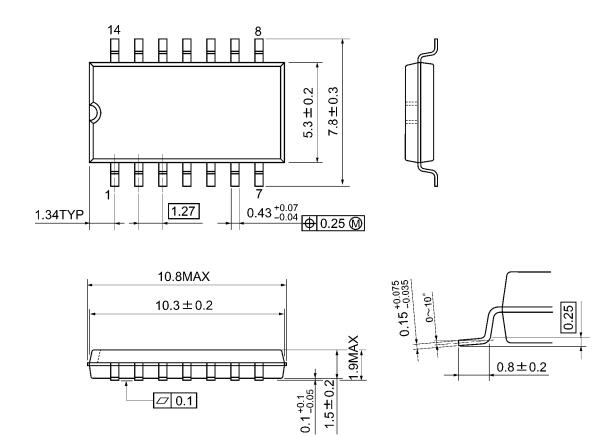
Weight: 0.96 g (typ.)



# **Package Dimensions**

SOP14-P-300-1.27A

Unit: mm



Weight: 0.18 g (typ.)

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